

High- Q Active Resonators Using Amplifiers and Their Applications to Low Phase-Noise Free-Running and Voltage-Controlled Oscillators

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Abstract—This paper presents a new technique to design high- Q active resonators. The active resonators are then used in the design of low phase-noise oscillators. The proposed new technique uses an amplifier to generate a negative resistance, which compensates for the resonator losses and increases the Q factor. The active resonator using this technique shows a high loaded Q factor of 548.62 from measurement at the fixed 10-GHz resonant frequency. Considerations to design a voltage tunable active resonator is given and measurements show that the loaded Q factors exceed 500 with a 120-MHz tuning range. A low phase-noise free-running and voltage-controlled oscillator (VCO) were designed as an application of the proposed active resonators. The phase noise of the free-running oscillator using the active resonator is -114.36 dBc/Hz at 100-kHz offset, which is 14 dB lower than the phase noise of the passive resonator oscillator. In the case of a VCO using the active resonator, the phase-noise performance is below -110 dBc/Hz over the whole tuning range, which is lower 13 dB compared to the passive resonator VCO. The total dc power consumptions are approximately 500 mW.

Index Terms—Active resonator, oscillator, phase noise, quality (Q) factor.

I. INTRODUCTION

MODERN communication systems require high-quality (Q) resonators for bandpass filters, bandstop filters, duplexers, and oscillators. The dielectric resonator and cavity resonator are promising elements for these applications, but they have a three-dimensional structure and their sizes are bulky. Therefore, they limit the on-chip integrated-circuit (IC) realization and are not adequate for mass production.

High- Q resonators are especially essential for low phase-noise oscillators. Phase noise is one of the most important parameters in a communication system because it affects the overall performance of the system. In recent years, there have been numerous attempts to reduce the phase noise of the planar oscillators, which have some advantages for low cost and improved reliability [1]–[7]. Nevertheless, their phase-noise characteristics are inferior due to the poor Q factor of the planar resonator.

To overcome the limitation of the Q factors of the planar resonators, various attempts to design the active high- Q resonators

have been reported and are good candidates for high-performance filters and oscillators. Usually, the active high- Q resonators are implemented based on the negative resistance circuit, which is used to compensate for the loss of the resonator and, as a result, the high- Q property can be obtained [8]–[13].

Although the negative-resistance circuits are widely used to implement the high- Q active resonators, they have the following drawbacks. First, the structure is somewhat complicated because they must have a feedback element and a matching circuit to produce the negative resistance. Second, spurious oscillation can occur if the oscillation start-up condition is satisfied. Hence, a careful design must be provided to generate negative resistance and to prevent unwanted oscillation.

In this paper, a new method to design high- Q active bandstop resonators without using a negative resistance circuit and their applications to the low phase-noise oscillators are proposed [14]. The operating principle, analysis, and measured results of the proposed active resonator are presented in Section II. In addition, extension to the voltage tunable active resonator is given in Section III. To validate the applicability of the active resonators to the low phase-noise oscillators, the free-running and voltage-controlled oscillator (VCO) employing the active resonators were designed and measured. These will be described in Sections IV and V.

II. PROPOSED HIGH- Q ACTIVE RESONATOR

A. Operating Principle

Fig. 1(a) shows one possible method to design a high- Q active bandstop resonator using the negative resistance circuit. To realize the negative resistance circuit, an active device with the feedback element is needed, which causes the complex structure and oscillation problem, as mentioned above. The basic theory of the active resonator using the negative resistance has been discussed in [8] and [13]. The loss of the resonator can be compensated by properly adjusting the negative resistance and the coupling coefficient between the resonator and negative resistance. Therefore, a lossless resonator can be obtained theoretically.

The schematic of the proposed high- Q active bandstop resonator using the amplifier is shown in Fig. 1(b). Unlike the previous one, an additional coupling port (port 3) is placed and an amplifier is located between ports 2 and port 3.

To understand the operating principle of the proposed active resonator, the analysis of the negative resistance circuit in

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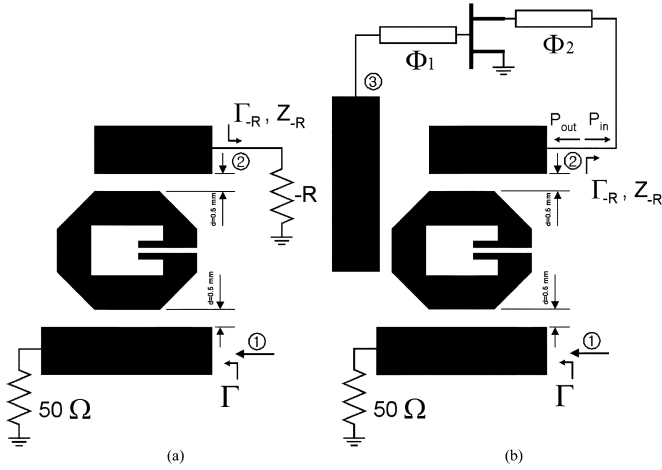


Fig. 1. High- Q active bandstop resonator using: (a) the negative resistance circuit. (b) The amplifier.

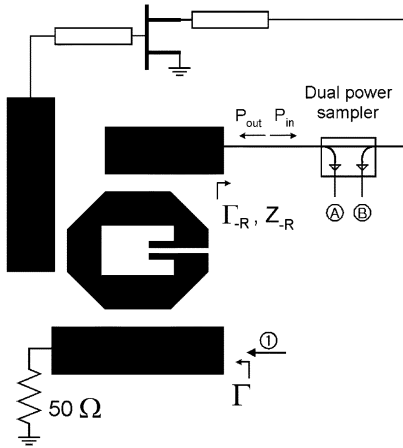


Fig. 2. Simulation setup to calculate the equivalent negative resistance seen from the resonator.

Fig. 1(a) should be performed. Basically, the negative resistance plays a role of reflection-type amplification of the signal, which means that the reflection coefficient (Γ_{-R}) seen from port 2 to the negative resistance circuit exceeds one near the resonant frequency.

The active resonator proposed in this paper shows similar operation. A power is injected into port 1 and coupled to ports 2 and 3. The power from port 3 is then amplified and injected to port 2 in the opposite direction, as shown in Fig. 1(b). By adjusting the phases (Φ_1, Φ_2) of the transmission lines located at the two coupling ports, $\Gamma_{-R}(P_{out}/P_{in})$ is larger than one, which suggests that Z_{-R} has negative resistance. In conclusion, the high- Q active resonator can be designed simply using the amplifier without the complicated negative resistance circuit.

B. Analysis

The equivalent negative resistance can be calculated from the linear circuit simulation. Fig. 2 shows the simulation setup to calculate the negative resistance.

Note that there are three ports (i.e., ports 1, A, and B) in this setup, and the dual-power sampler, which is an ideal device, is included in the active resonator circuit. The dual-power sampler

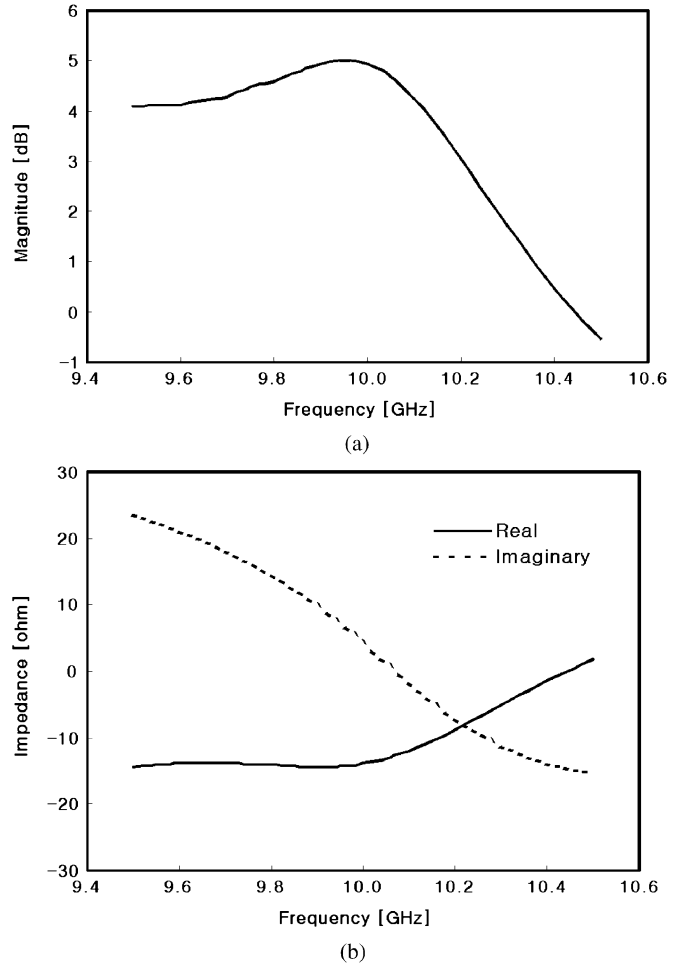


Fig. 3. Calculated equivalent: (a) $|\Gamma_{-R}|$ and (b) Z_{-R} .

plays a role of sampling the power from the resonator (P_{in}) and power to the resonator (P_{out}), and they are equal to S_A^- and S_B^- , respectively. Therefore, the equivalent reflection coefficient seen from the resonator (Γ_{-R}) and input impedance (Z_{-R}) can be calculated using the following equation:

$$\Gamma_{-R} = \frac{P_{out}}{P_{in}} = \frac{S_B^-}{S_A^-} = \frac{S_B^-/S_1^+}{S_A^-/S_1^+} = \frac{S_{B1}}{S_{A1}}. \quad (1)$$

Fig. 3 shows the equivalent $|\Gamma_{-R}|$ and resulting input impedance Z_{-R} obtained from the circuit simulation. It is calculated that Γ_{-R} is 5 dB and Z_{-R} is $-13.9 + 4.3j \Omega$ at the resonant frequency.

One may doubt that there is a possibility of oscillation because the amplifier is located in a closed loop. However, the coupling coefficient between ports 2 and 3 in Fig. 1(b) is very weak (below -10 dB), which indicates that the loop gain of the closed loop is less than unity at whole frequency bands, as shown in Fig. 4. Therefore, no oscillation can occur. The loop gains must be checked in other values of port-1 terminations such as reactive terminations. Since the transmission coefficients S_{21} and S_{31} in Fig. 1(b) are very weak (below -10 dB), the port-1 termination does not affect the loop gain characteristics seriously. Actually the variance of the magnitude of S_{32} in Fig. 1(b) is within 2 dB when port 1 is terminated in reactive impedance. From the circuit simulation, it was found that the loop gains

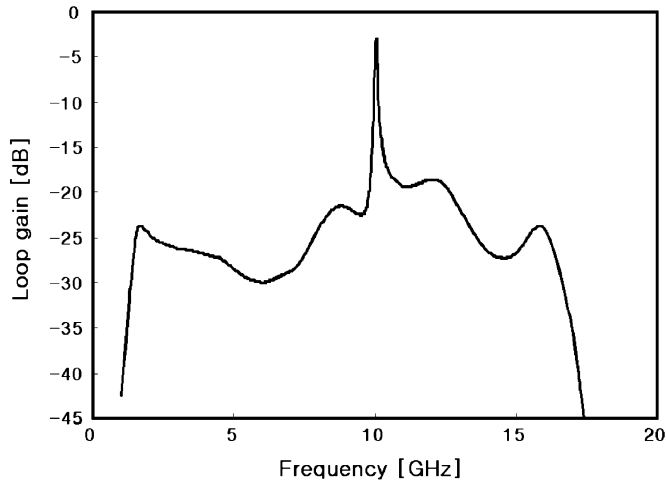


Fig. 4. Characteristics of the loop gain. Port 1 is terminated in $50\ \Omega$.

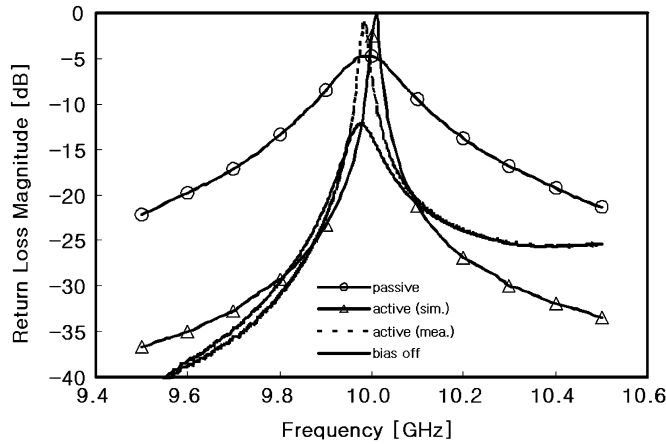


Fig. 5. Frequency responses (Γ) of the passive resonator (measurement), active resonator (simulation and measurement), and active resonator when the bias is off (measurement).

were slightly increased in the case of reactive port-1 terminations, but also less than unity.

C. Fabrication and Measurements

The active resonator was fabricated using a Teflon substrate of 0.504-mm thickness and the dielectric constant of 2.52 with the hybrid technique. The TC 2381 medium power device was used as an amplifier to be operated in the linear region.

The simulated and measured return-loss results of the proposed active bandstop resonator are in good agreement, as shown in Fig. 5. The loaded Q factor from the measurement is calculated to be 548.62. For comparison, a passive resonator strongly coupled to the microstrip line is also fabricated and measured. The measured result of the passive resonator is also shown in Fig. 5 and the loaded Q factor is calculated to be 65.72.

III. VOLTAGE TUNABLE HIGH- Q ACTIVE RESONATOR

Fig. 6 shows the circuit diagram of the voltage tunable high- Q active resonator. The varactor diode is attached to change the resonant frequency of the resonator. The MA 46H120 was used

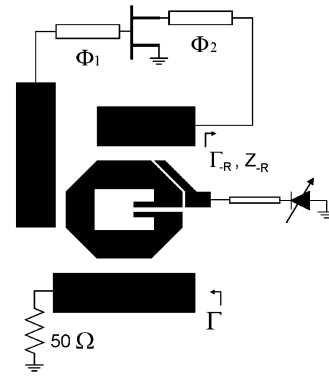


Fig. 6. Circuit diagram of the proposed voltage tunable high- Q active resonator.

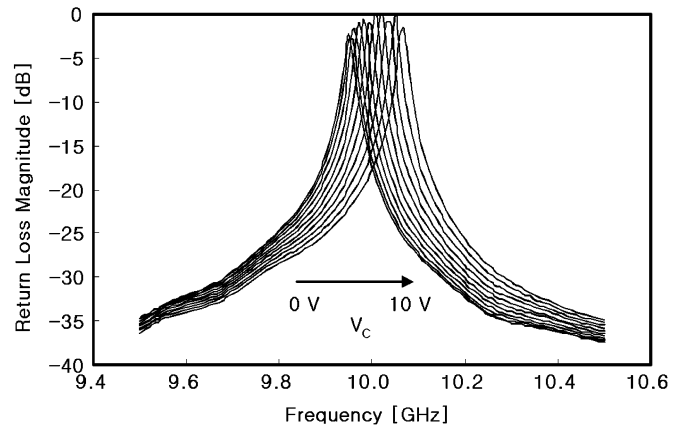


Fig. 7. Frequency response (Γ) of the voltage tunable active resonator. The tuning range is 120 MHz.

and its capacitance is varied from 0.9 to 0.2 pF for control voltages of 1–10 V.

The operating principle and design procedure of this voltage tunable active resonator are identical to those of the fixed frequency active resonator.

The voltage tunable active resonator based on the negative resistance circuit can be implemented just by attaching the varactor diode in Fig. 1(a). Since the negative resistance in Fig. 1(a) is not an ideal device in reality, its value is not constant versus frequency. Moreover, the negative resistance does not dependent on the varactor diode control voltages. This indicates that the performance of the voltage tunable active resonator using negative resistance can be degraded varying the resonant frequency. In some cases, the oscillation can occur when the negative resistance circuit is modified to fulfill the desired performances at the whole tuning range.

On the other hand, in the case of the proposed voltage tunable active resonator in Fig. 6, the varactor diode control voltages can change both the resonant frequency and Z_{-R} at the resonant frequency. This arises from the fact that the characteristics of the closed loop are changed depending on the resonant frequency. Therefore, it is possible to achieve high input reflection coefficients (Γ) and high loaded Q 's at the whole tuning ranges.

Fig. 7 shows the measured characteristics of the voltage tunable active resonator. The loaded Q is larger than 500 at the all resonant frequencies.

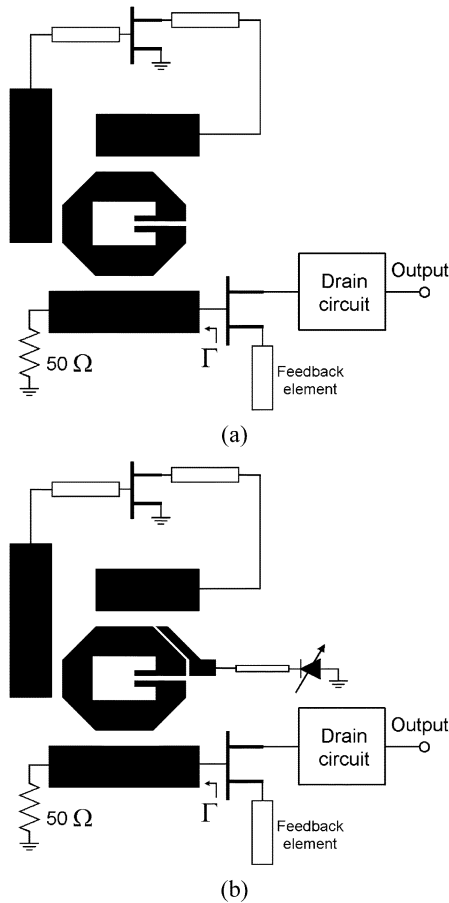


Fig. 8. Schematics of the: (a) free-running ARO and (b) VCARO.

IV. DESIGN OF OSCILLATORS USING HIGH- Q ACTIVE RESONATORS

The schematics of the free-running active resonator oscillator (ARO) and the voltage-controlled active resonator oscillator (VCARO) are shown in Fig. 8(a) and (b), respectively. The active devices for the oscillators are NE 32584 high electron-mobility transistor (HEMT) devices and they were designed using the nonlinear simulation approach [15]. The oscillation frequency of the free-running ARO is 10 GHz, which is the resonant frequency of the active resonator. In the case of a VCARO, the oscillation frequencies are changed according to the control voltages of the varactor diode, as described in Section III.

The free-running passive resonator oscillator (PRO) and the voltage-controlled passive resonator oscillator (VCPRO) were also fabricated to compare the Q factors and resulting phase-noise performances. Note that the source and drain circuits of the oscillators using the passive resonators are identical to those of the oscillators using the active resonators.

V. MEASURED RESULTS OF THE AROS

A. Free-Running Oscillators

The phase-noise characteristics of the free-running ARO and PRO were measured using the Agilent E4448A spectrum analyzer. Fig. 9 depicts the measured phase-noise results of these two oscillators depending on the bias voltages. The phase noises

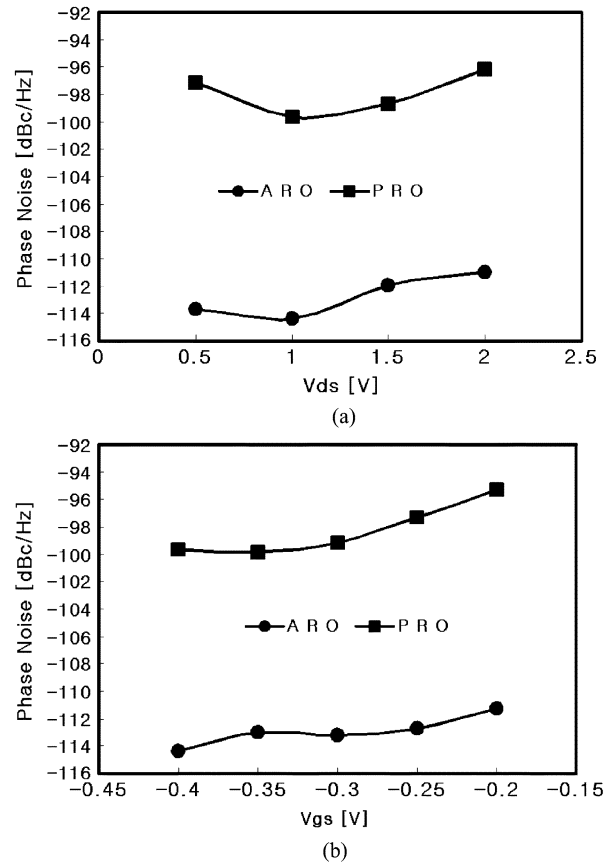


Fig. 9. Measured phase-noise characteristics of the ARO and PRO at 100-kHz offset. (a) Depending on the drain bias voltages ($V_{gs} = -0.4$ V). (b) Depending on the gate bias voltages ($V_{ds} = 1$ V).

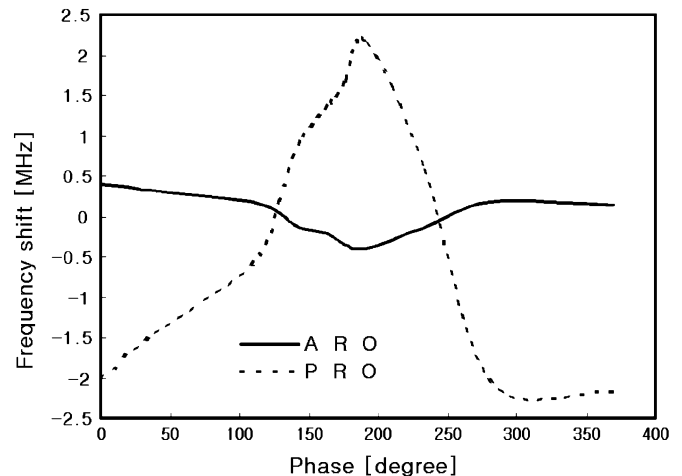


Fig. 10. Measured oscillation frequency deviation ($V_{SWR} = 1.0933$).

of the ARO are lower than those of the PRO by 14–15 dB. The output powers of the ARO and PRO are 10.74 and 6.19 dBm, respectively, at $V_{gs} = -0.4$ V and $V_{ds} = 2$ V.

To demonstrate the high-quality property of the ARO and compare it with the Q factor of the PRO, the pulling figure must be measured [16]. The pulling figure means the maximum oscillation frequency deviation for a load mismatch of all phases. In the experiment, the pulling figures of these two oscillators were measured for the load voltage standing wave ratio (VSWR)

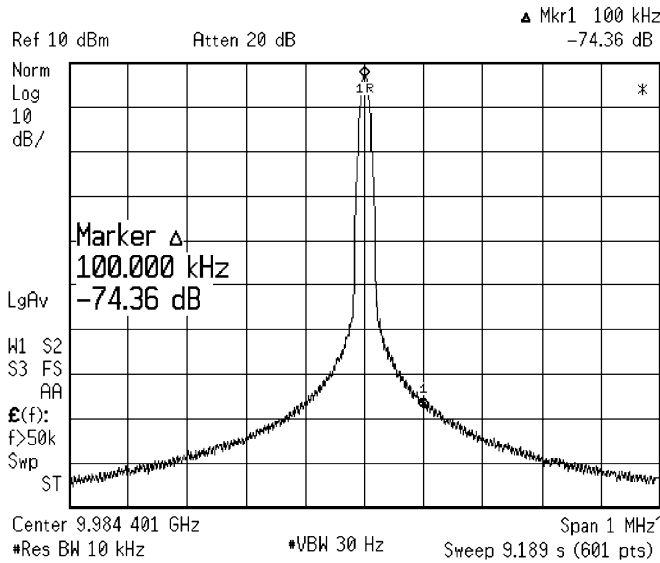


Fig. 11. Output spectrum of the ARO ($V_{gs} = -0.4$ V, $V_{ds} = 1$ V).

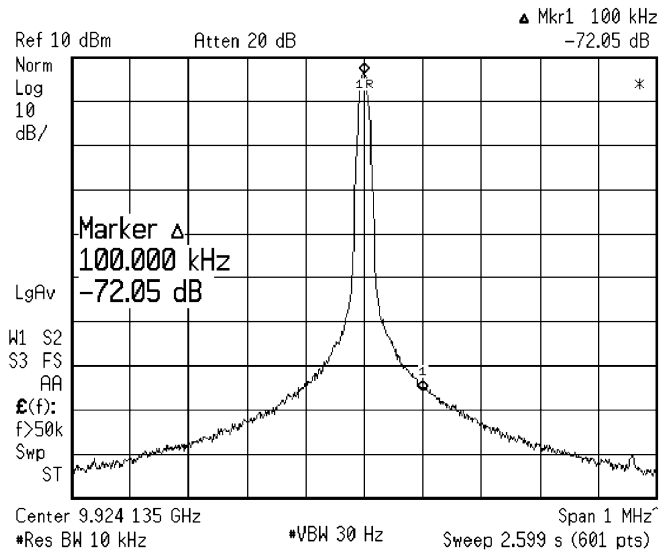


Fig. 14. Output spectrum of the VCARO ($V_{gs} = -0.4$ V, $V_{ds} = 1$ V).

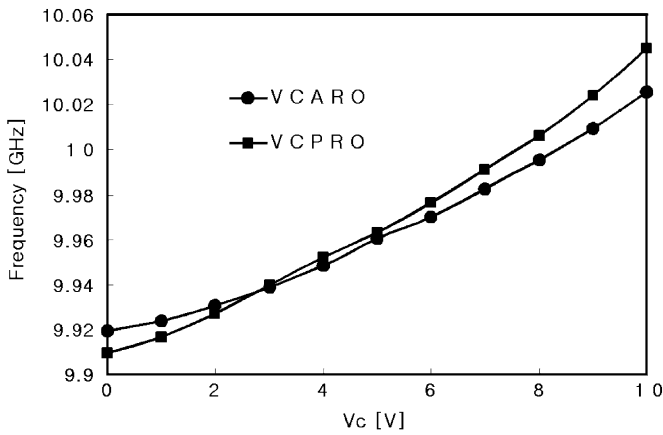


Fig. 12. Tuning ranges of the VCARO and VCPRO versus the control voltages of the varactor diode.

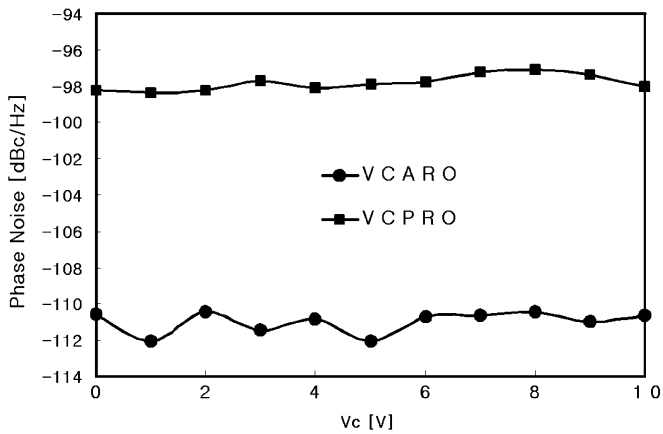


Fig. 13. Measured phase-noise characteristics of the VCARO and VCPRO versus the control voltages of the varactor diode ($V_{gs} = -0.4$ V, $V_{ds} = 1$ V).

of 1.0993. Under this condition, the maximum oscillation frequency deviations of the ARO and PRO are 0.78 and 4.36 MHz, as shown in Fig. 10. This gives rise to the external Q factor of 1211 and 216.6, respectively. This indicates that the ratio

TABLE I
COMPARISON BETWEEN THIS STUDY AND OTHER PLANAR TECHNOLOGIES

References	Resonator Technology	Device	Fo (GHz)	Phase Noise (dBc/Hz @ 100KHz)
[3]	Hairpin	Silicon bipolar	9 (320 MHz)	-112
[4]	Planar waveguide cavity	HEMT	15	-98
[5]	Substrate waveguide cavity	HEMT	12	-73
[6]	Ring resonator	HEMT	12.09	-96.17
[7]	μ -strip	Silicon bipolar	9.95 (60MHz)	-113
This work	Active resonator	HEMT	10	-114.36
This work (VCO)	Active resonator	HEMT	10 (107MHz)	-112.05

of the external Q 's is 5.59 and 14.9-dB phase-noise improvement is expected. This is in good agreement with the measured phase-noise results.

The output spectrum of the ARO is illustrated in Fig. 11 and it shows -114.36 dBc/Hz at 100-kHz offset.

B. VCOs

Fig. 12 shows the measured oscillation frequencies versus the varactor control voltages. The tuning ranges of the VCARO and VCPRO are 107 and 135 MHz, respectively.

The measured phase-noise performances are shown in Fig. 13. It should be noted that the phase noises of the VCARO are below -110 dBc/Hz at 100-kHz offset for the whole tuning range due to the good performance of the voltage tunable active resonator. To the best of our knowledge, it is lower or comparable to the phase-noise performances in [3] and [7], which used low-noise silicon devices for VCOs at X -band. Fig. 14 shows the output spectrum of the VCARO.

Table I shows the comparison of oscillator phase-noise performances between the proposed ARO, VCARO, and other oscillator technologies.

VI. CONCLUSION

A new design technique of the high- Q active resonators using amplifiers for planar structures has been proposed. It overcomes the difficulties of the conventional active resonators using negative-resistance circuits such as design complexity, oscillation, and hard tunable problems. An analysis procedure to calculate the equivalent negative resistance using computer-aided design (CAD) has been discussed. A fixed and voltage tunable active resonators using the proposed technique has been designed and their loaded Q factors have been shown to be larger than 500 from measurements.

To demonstrate the applicability of the proposed active resonators, the phase-noise performances of the free-running oscillators and VCOs employing the active resonators have been measured. Due to the high- Q factors of the proposed active resonators, the active resonators oscillators exhibit low phase-noise results, -114.36 dBc/Hz for the free-running oscillator and below -110 dBc/Hz for the VCO at 100-kHz offset.

In addition, it is expected that the proposed active resonator scheme can be applied to other circuits such as bandpass filters and parallel-feedback oscillators.

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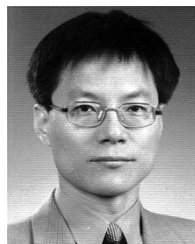
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